

# 16 Channel Constant Current LED Driver with Ghosting Elimination

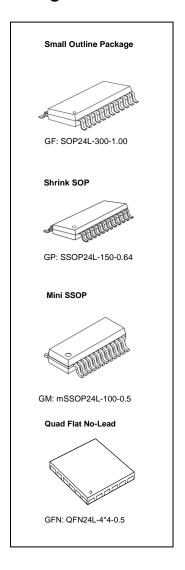
#### **Features**

- 16 constant-current output channels
- Constant output current invariant to load voltage change:
   Constant output current range:
  - 1-25mA@V<sub>DD</sub>=5V;
  - 1-10mA@V<sub>DD</sub>=3.3V
- Excellent output current accuracy:

between channels:  $\pm 1.5\%$  (typ.) and  $\pm 2.5\%$  (max.)

between ICs:  $\pm 1.5\%$  (typ.) and  $\pm 3\%$  (max.)

- Output current adjusted through an external resistor
- Fast response of output current, OE (min.): 50ns with good uniformity between output channels
- Integrating ghosting elimination
- Staggered delay of output
- 25MHz clock frequency
- Schmitt trigger input
- 3.3V/ 5V supply voltage
- "Pb-free & Green" Package

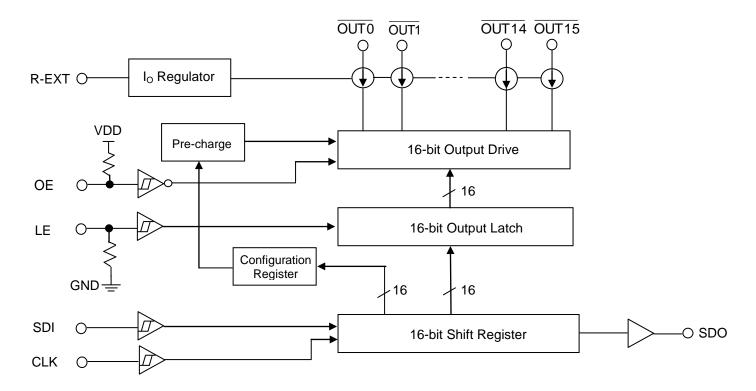


## **Product Description**

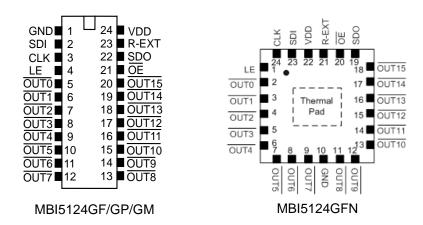
With PrecisionDrive™ technology, MBI5124 is designed for LED displays which require to operate at low current and to match the luminous intensity of each channel. It provides supply voltage and accepts CMOS logic input at 3.3V and 5.0V to meet the trend of low power consumption. MBI5124 contains a serial buffer and data latches which convert serial input data into parallel output format. At MBI5124 output stage, sixteen regulated current ports are designed to provide uniform and constant current sinks for driving LEDs within a large range of V<sub>F</sub> variations. Besides, MBI5124 integrates the pre-charge circuit which can relieve the ghosting.

MBI5124 provides users with great flexibility and device performance while using MBI5124 in their system design for LED display applications, e.g. LED panels. It accepts an input voltage range from 3.3V to 5V and maintains a constant current up from 1mA to 25mA determined by an external resistor, R<sub>ext</sub>, which gives users flexibility in controlling the light intensity of LEDs. MBI5124 guarantees to endure maximum 17V at the output port. The high clock frequency, 25 MHz, also satisfies the system requirements of high volume data transmission.

#### **Block Diagram**



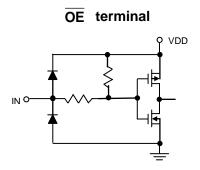
#### **Pin Configuration**

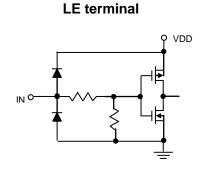


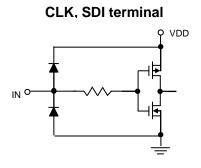
### **Terminal Description**

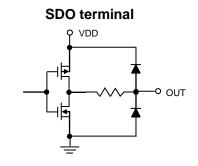
| Pin Name   | Function  |
|------------|---|
| GND        | Ground terminal for control logic and current sink  |
| SDI        | Serial-data input to the shift register   |
| CLK        | Clock input terminal for data shift on rising edge  |
| LE         | Data strobe input terminal Serial data is transferred to the output latch when LE is high. The data is latched when LE goes low.  |
| OUT0~OUT15 | Constant current output terminals   |
| ŌĒ         | Output enable terminal When (active) low, the output drivers are enabled; when high, all output drivers are turned OFF (blanked). |
| SDO        | Serial-data output to the following SDI of next driver IC. SDO signal change on rising edge of CLK.                               |
| R-EXT      | Input terminal used to connect an external resistor for setting up output current for all output channels                         |
| VDD        | 3.3V/5V supply voltage terminal   |

# **Equivalent Circuits of Inputs and Outputs**

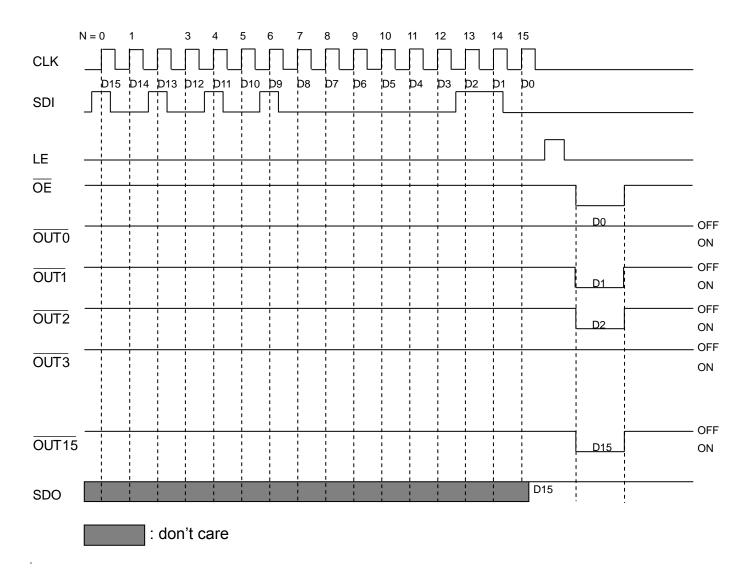








# **Timing Diagram**



#### **Truth Table**

| CLK      | LE | ŌĒ | SDO              |   |                   |
|----------|----|----|------------------|---|-------------------|
| <u>_</u> | Н  | L  | D <sub>n</sub>   | <u>D</u> n <u>D</u> n - 7 <u>D</u> n - 15                               | D <sub>n-15</sub> |
| <u>_</u> | L  | L  | D <sub>n+1</sub> | No Change   | D <sub>n-14</sub> |
| <u>_</u> | Н  | L  | D <sub>n+2</sub> | $\overline{D_{n+2}} \dots \overline{D_{n-5}} \dots \overline{D_{n-13}}$ | D <sub>n-13</sub> |
| <b>—</b> | Х  | L  | D <sub>n+3</sub> | <u>Dn+2</u> <u>Dn-5</u> <u>Dn-13</u>                                    | D <sub>n-13</sub> |
| <b>—</b> | Х  | Н  | D <sub>n+4</sub> | Off   | D <sub>n-13</sub> |

#### **Maximum Ratings**

| С                         | haracteristic |               | Symbol           | Rating                    | Unit |
|---------------------------|---------------|---------------|------------------|---------------------------|------|
| Supply Voltage            |               |               | $V_{DD}$         | 0~7.0                     | V    |
| Input Voltage(SDI, C      | LK, LE, GCLK) |               | V <sub>IN</sub>  | -0.4~V <sub>DD</sub> +0.4 | V    |
| Output Current            |               |               | I <sub>OUT</sub> | +30                       | mA   |
| Sustaining Voltage a      | t OUT Port    |               | $V_{DS}$         | V <sub>DD</sub> +0.3      | V    |
| <b>GND Terminal Curre</b> | nt            |               | I <sub>GND</sub> | 480                       | mA   |
|                           |               | GF-type       |                  | 2.34                      |      |
| Power Dissipation         |               | GP-type       | В                | 1.76                      | W    |
| (On PCB, Ta=25°C)*        |               | GM-type       | $P_{D}$          | 1.33                      | VV   |
|                           |               | GFN-type      |                  | 3.12                      |      |
|                           |               | GF-type       |                  | 53.28                     |      |
| Thermal Resistance        | GP-type       |               | Б                | 70.90                     | 0000 |
| (On PCB, Ta=25°C)*        |               | GM-type       | $R_{th(j-a)}$    | 93.5                      | °C/W |
|                           |               | GFN-type      |                  | 40.01                     |      |
| Junction Temperature      | )             |               | $T_{j,max}$      | 150**                     | °C   |
| Operating Ambient Te      | emperature    |               | $T_{opr}$        | -40~+85                   | °C   |
| Storage Temperature       |               |               | $T_{stg}$        | -55~+150                  | °C   |
| HBM(MIL-STD-              |               | 83G Method    | HBM              | Class 3A                  |      |
| 3015 7)                   |               |               | ПОІ              | (5000V)                   |      |
| ESD Rating                | MM/ IEDEC EIA | /IECD22 A44E\ | N 4 N 4          | Class M4                  |      |
|                           | MM(JEDEC EIA  | (JESD22-A115) | MM               | (≥400V)                   |      |

<sup>\*</sup>The PCB size is 76.2mm\*114.3mm in simulation. Please refer to JEDEC JESD51.

Note: The performance of thermal dissipation is strongly related to the size of thermal pad, thickness and layer numbers of the PCB. The empirical thermal resistance may be different from simulative value. Users should plan for expected thermal dissipation performance by selecting package and arranging layout of the PCB to maximize the capability.

<sup>\*\*</sup> Operation at the maximum rating for extended periods may reduce the device reliability; therefore, the suggested junction temperature of the device is under 125°C.

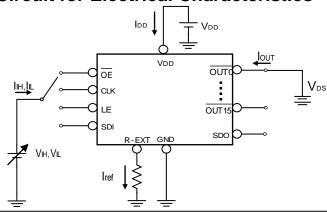
# Electrical Characteristics ( $V_{DD}$ = 5.0V, Ta=25 $^{\circ}$ C)

| Character                             | istics   | Symbol                                  | Cond  | dition                  | Min.                 | Тур.  | Max.                  | Unit |
|---------------------------------------|--|---|---|-------------------------|----------------------|-------|-----------------------|------|
| Supply Voltage                        |  | $V_{DD}$                                | -   |                         | 4.5                  | 5.0   | 5.5                   | V    |
| Sustaining Voltage Ports              | ge at OUT  | V <sub>DS</sub>                         | OUT0~OUT15  | i                       | V <sub>DD</sub> +0.3 | -     | -                     | V    |
|                                       |  | I <sub>OUT</sub>                        | Refer to "Test C<br>Characteristics"  | 1.0                     | -                    | 25    | mA                    |      |
| Output Current                        |  | I <sub>OH</sub>                         | SDO   |                         | -                    | -1.0  | -                     | mA   |
|                                       |  | I <sub>OL</sub>                         | SDO   |                         | -                    | 1.0   | -                     | mA   |
| Innut Valtage                         | "H" level V <sub>IH</sub> T <sub>a</sub> =-40~85°C |   |   |                         |                      | -     | $V_{DD}$              | V    |
| Input Voltage                         | "L" level  | V <sub>IL</sub>                         | T <sub>a</sub> =-40~85°C  |                         | GND                  | -     | 0.3 x V <sub>DD</sub> | V    |
| Output Leakage (                      | Current  | I <sub>OH</sub>                         | V <sub>DD</sub> +0.3V   |                         | 100                  | -     | -                     | nA   |
| Output Voltage                        | age SDO V <sub>OL</sub> I <sub>OL</sub> =+1.0mA    |   |   |                         |                      | -     | 0.4                   | V    |
| Output voltage                        | 300  | V <sub>OH</sub> I <sub>OH</sub> =-1.0mA |   |                         |                      |       | -                     | ٧    |
| Current Skew (Ch                      | nannel)  | dl <sub>OUT1</sub>                      | I <sub>OUT</sub> =10.05mA<br>V <sub>DS</sub> =1.0V  | R <sub>ext</sub> =1820Ω | -                    | ±1.5  | ±2.5                  | %    |
| Current Skew (IC                      | )  | dl <sub>OUT2</sub>                      | I <sub>OUT</sub> =10.05mA<br>V <sub>DS</sub> =1.0V  | R <sub>ext</sub> =1820Ω | -                    | ±1.5  | ±3.0                  | %    |
| Output Current vs<br>Output Voltage R |  | %/dV <sub>DS</sub>                      | V <sub>DS</sub> within 1.0V   | -                       | ±0.1                 | ±0.3  | %/V                   |      |
| Output Current vs<br>Supply Voltage R | 3.   | %/dV <sub>DD</sub>                      | V <sub>DD</sub> within 4.5V   | -                       | ±0.5                 | ±1.0  | %/V                   |      |
| Pull-up Resistor                      |  | R <sub>IN</sub> (up)                    | ŌE  |                         | 125                  | 350   | 600                   | ΚΩ   |
| Pull-down Resisto                     | or   | R <sub>IN</sub> (down)                  | LE  |                         | 125                  | 350   | 600                   | ΚΩ   |
|                                       |  | I <sub>DD</sub> (off) 1                 | R <sub>ext</sub> =Open, <del>OU</del>   | T0 ~ OUT15 =Off         | -                    | 3.0   | -                     |      |
|                                       | "OFF"  | I <sub>DD</sub> (off) 2                 | $\frac{R_{ext}=1820\Omega, (10)}{OUT0} \sim \frac{1}{OUT15} = Ofton$                              | ,                       | -                    | 6.80  | -                     |      |
| Supply Current                        |  | I <sub>DD</sub> (off) 3                 | $R_{\text{ext}} = 1050\Omega$ , (18.8 $\overline{\text{OUT0}} \sim \overline{\text{OUT15}} = 01$  |                         | -                    | 10.09 | -                     | mA   |
|                                       | "61"   | I <sub>DD</sub> (on) 1                  | R <sub>ext</sub> =1820Ω, (10<br>OUT0 ~ OUT15 =Or  |                         | -                    | 6.92  | -                     |      |
|                                       | "ON"   | I <sub>DD</sub> (on) 2                  | $R_{\text{ext}} = 1050\Omega$ , (18.8 $\overline{\text{OUT0}} \sim \overline{\text{OUT15}} = 0$ i |                         | -                    | 10.31 | -                     |      |

# Electrical Characteristics ( $V_{DD}$ = 3.3V, Ta=25 $^{\circ}$ C)

| Characte                         | ristics   | Symbol                  | Condi  | ition        | Min.                 | Тур.                | Max.     | Unit |
|----------------------------------|---|-------------------------|--|--------------|----------------------|---------------------|----------|------|
| Supply Voltage                   |   | $V_{DD}$                | -  |              | 3.0                  | 3.3                 | 3.6      | V    |
| Sustaining Volt<br>Ports         | age at OUT  | $V_{DS}$                | OUT0~OUT15   |              | V <sub>DD</sub> +0.3 | -                   | -        | V    |
|                                  |   | I <sub>OUT</sub>        | Refer to "Test Circ<br>Characteristics"  | 1            | -                    | 10                  | mA       |      |
| Output Current                   |   | I <sub>OH</sub>         | SDO , V <sub>OH</sub> =2.9V  |              | -                    | -1.0                | -        | mA   |
|                                  |   | I <sub>OL</sub>         | SDO, V <sub>OL</sub> =0.4V   |              | -                    | 1.0                 | -        | mA   |
| Input Voltage                    | "H" level V <sub>IH</sub> T <sub>a</sub> =-40~85°C  |                         |  |              |                      | -                   | $V_{DD}$ | V    |
| input voitage                    | "L" level   | $V_{IL}$                | T <sub>a</sub> =-40~85°C   | GND          | -                    | $0.3 \times V_{DD}$ | V        |      |
| Output Leakag                    | e Current   | I <sub>OH</sub>         | V <sub>DD</sub> +0.3V  |              | 100                  | -                   | -        | nA   |
| Output Voltage                   | SDO   | V <sub>OL</sub>         | I <sub>OL</sub> =+1.0mA  |              | -                    | -                   | 0.4      | V    |
| Output Voltage                   | 300   | V <sub>OH</sub>         | I <sub>OH</sub> =-1.0mA  | 2.9          | -                    | -                   | V        |      |
| Current Skew                     | rrent Skew $ dI_{OUT1} \qquad \begin{matrix} I_{OUT} = 25.8 \text{mA} \\ V_{DS} = 1.0 \text{V} \end{matrix} \qquad \text{Rext} = 720 \Omega $ |                         |  |              |                      | ±1.5                | ±2.5     | %    |
| Current Skew                     |   | dl <sub>OUT2</sub>      | $I_{OUT}$ =25.8mA $V_{DS}$ =1.0V Rext=720 $\Omega$   |              | -                    | ±1.5                | ±3.0     | %    |
| Output Current of Output Voltage |   | %/dV <sub>DS</sub>      | V <sub>DS</sub> within 1.0V ar   | nd 3.0V      | -                    | ±0.1                | ±0.3     | %/V  |
| Output Current Supply Voltage    |   | %/dV <sub>DD</sub>      | V <sub>DD</sub> within 3.0V a  | nd 4.5V      | -                    | ±0.5                | ±1.0     | %/V  |
| Pull-up Resistor                 | •   | R <sub>IN</sub> (up)    | ŌĒ   |              | 125                  | 350                 | 600      | ΚΩ   |
| Pull-down Resis                  | stor  | R <sub>IN</sub> (down)  | LE   |              | 125                  | 350                 | 600      | ΚΩ   |
|                                  |   | I <sub>DD</sub> (off) 1 | R <sub>ext</sub> = Open, OUT   | 0~ OUT15=Off | -                    | 2.45                | -        |      |
|                                  | "OFF" $I_{DD}(off) \ 2 \qquad \frac{R_{ext} = 1820\Omega, (10.05mA)}{OUT0 \sim OUT15} = Off$  |                         | •  | -            | 6.42                 | -                   |          |      |
| Supply Current                   |   | I <sub>DD</sub> (off) 3 | $R_{ext}$ =16KΩ, (1.14n $\overline{OUT0} \sim \overline{OUT15}$ =Off                                       | nA)          | -                    | 2.53                | -        | mA   |
|                                  |   | I <sub>DD</sub> (on) 1  | $R_{\text{ext}} = 1820\Omega$ , (10.)<br>$\overline{\text{OUT0}} \sim \overline{\text{OUT15}} = \text{On}$ | 05mA)        | -                    | 6.52                | -        |      |
|                                  | "ON"  |                         | $R_{ext}$ =16KΩ, (1.14n $\overline{OUT0} \sim \overline{OUT15}$ =Off                                       |              | -                    | 2.55                | -        |      |

### **Test Circuit for Electrical Characteristics**



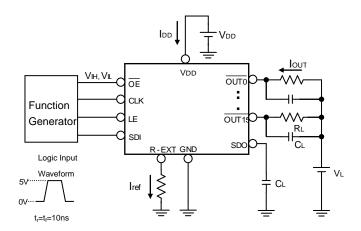
# Switching Characteristics (V<sub>DD</sub>= 5.0V , Ta=25 °C)

| Charact                      | eristics     | Symbol              | Condition                                 | Min. | Тур. | Max. | Unit |
|------------------------------|--------------|---------------------|---|------|------|------|------|
| Propagation Delay            | LE-OUT0      | t <sub>pLH2</sub>   |   | 23   | 29   | 35   | ns   |
| Time                         | OE - OUT 0   | t <sub>pLH3</sub>   |   | 19   | 24   | 29   | ns   |
| ("L" to "H")                 | CLK-SDO      | t <sub>pLH</sub>    |   | 23   | 29   | 35   | ns   |
| Propagation Delay            | LE-OUT0      | t <sub>pHL2</sub>   |   | 15   | 19   | 23   | ns   |
| Time                         | OE - OUT 0   | t <sub>pHL3</sub>   |   | 19   | 25   | 31   | ns   |
| ("H" to "L")                 | CLK-SDO      | t <sub>pHL</sub>    |   | 22   | 28   | 34   | ns   |
| Staggered Delay of<br>Output | OUTn-OUTn+1  | t <sub>stag</sub>   | $V_{DD}$ =5.0V<br>$V_{DS}$ =1.0V          | -    | 2    | -    | ns   |
|                              | CLK          | t <sub>w(CLK)</sub> | $V_{IH}=V_{DD}$                           | 20   | -    | -    | ns   |
| Pulse Width                  | LE           | t <sub>w(L)</sub>   | $V_{IL}$ =GND<br>$R_{ext}$ =1820 $\Omega$ | 20   | -    | -    | ns   |
|                              | OE *         | $t_{w(OE)}$         | $V_L=4.0V$                                | 45   | 55   | 65   | ns   |
| Hold Time for LE             |              | t <sub>h(L)</sub>   | $R_L=300\Omega$<br>$C_L=10pF$             | 5    | -    | -    | ns   |
| Setup Time for LE            |              | t <sub>su(L)</sub>  | - •                                       | 5    | -    | -    | ns   |
| Hold Time for SDI            |              | t <sub>h(D)</sub>   |   | 5    | -    | -    | ns   |
| Setup Time for SDI           |              | t <sub>su(D)</sub>  |   | 3    | -    | -    | ns   |
| SDO Rise Time                |              | $t_{r,SDO}$         |   | 3    | 10   | 15   | ns   |
| SDO Fall Time                |              | 3                   | 10  | 15   | ns   |      |      |
| Output Rise Time of          | Output Ports | t <sub>or</sub>     | 25 30 39                                  |      |      |      | ns   |
| Output Fall Time of 0        | Output Ports | t <sub>of</sub>     |   | 25   | 30   | 39   | ns   |

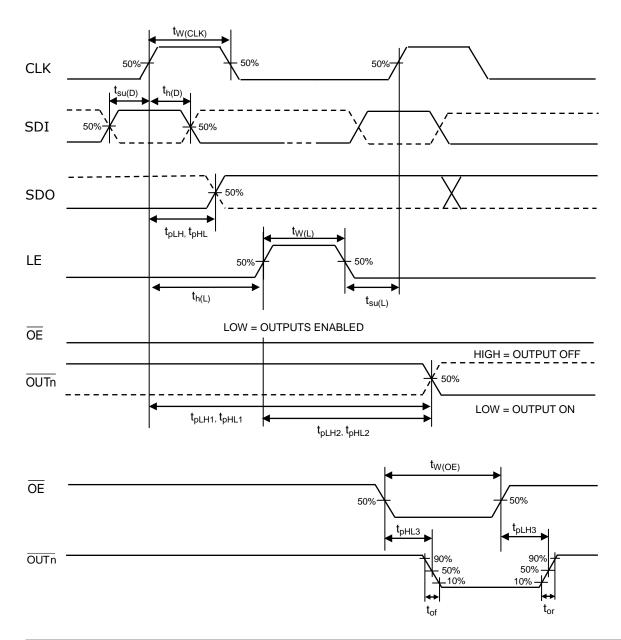
# Switching Characteristics ( $V_{DD}$ = 3.3V , Ta=25 °C)

| Charact                      | eristics     | Symbol              | Condition                              | Min. | Тур. | Max. | Unit |
|------------------------------|--------------|---------------------|--|------|------|------|------|
| Propagation Delay            | LE-OUT0      | t <sub>pLH2</sub>   |  | 23   | 29   | 35   | ns   |
| Time                         | OE - OUT0    | t <sub>pLH3</sub>   |  | 29   | 37   | 45   | ns   |
| ("L" to "H")                 | CLK-SDO      | t <sub>pLH</sub>    |  | 34   | 42   | 50   | ns   |
| Propagation Delay            | LE-OUT0      | t <sub>pHL2</sub>   |  | 14   | 18   | 22   | ns   |
| Time                         | OE - OUT 0   | t <sub>pHL3</sub>   |  | 22   | 28   | 34   | ns   |
| ("H" to "L")                 | CLK-SDO      | $t_{pHL}$           |  | 32   | 40   | 48   | ns   |
| Staggered Delay of<br>Output | OUTn-OUTn+1  | t <sub>stag</sub>   | $V_{DD}=3.3V$                          | -    | 2    | -    | ns   |
|                              | CLK          | t <sub>w(CLK)</sub> | $V_{DS}$ =1.0 $V_{IH}$ = $V_{DD}$      | 20   | ı    | -    | ns   |
| Pulse Width                  | LE           | $t_{w(L)}$          | $V_{IL}$ =GND                          | 20   | -    | -    | ns   |
|                              | OE *         | t <sub>w(OE)</sub>  | $R_{ext} = 1820\Omega$<br>$V_1 = 4.0V$ | 50   | 60   | 70   | ns   |
| Hold Time for LE             |              | t <sub>h(L)</sub>   | $R_L=300\Omega$                        | 5    | -    | -    | ns   |
| Setup Time for LE            |              | t <sub>su(L)</sub>  | C <sub>L</sub> =10pF                   | 5    | -    | -    | ns   |
| Hold Time for SDI            |              | t <sub>h(D)</sub>   |  | 5    | -    | -    | ns   |
| Setup Time for SDI           |              | t <sub>su(D)</sub>  |  | 3    | -    | -    | ns   |
| SDO Rise Time                |              | $t_{r,SDO}$         |  | 3    | 10   | 15   | ns   |
| SDO Fall Time                |              | $t_{f,SDO}$         |  | 3    | 10   | 15   | ns   |
| Output Rise Time of          | Output Ports | t <sub>or</sub>     |  | 25   | 30   | 40   | ns   |
| Output Fall Time of (        | Output Ports | t <sub>of</sub>     |  | 25   | 30   | 40   | ns   |

### **Test Circuit for Switching Characteristics**



### **Timing Waveform**



#### **Control Command**

|                     | Sigi | nals Combination                                    | Description   |
|---------------------|------|---|---|
| Command Name        | LE   | Number of CLK<br>Rising Edge when<br>LE is asserted | The Action After a Falling Edge of LE   |
| Latch data          | High | 0   | Latch the serial data to the output latch.  Latch the serial data to the driver's internal latch. |
|                     | High | 1   | Latch the serial data/Buffer data to the output latch.  |
| Write configuration | High | 4   | Serial data are transferred to the "configuration register"                                       |
| Read configuration  | High | 5   | "Configuration register" is shifted out to SDO.   |
| No Action           | High | 2,3, >5   | No action. Please do not use it.  |

# **Definition of Configuration Register**

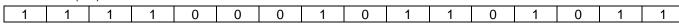
| MSB |   |   |   |   |   |   |   |   |   |   |   |   |   | I | LSB |
|-----|---|---|---|---|---|---|---|---|---|---|---|---|---|---|-----|
| F   | Е | D | С | В | Α | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0   |

According the driven LED, please set the configuration register by the following settings:

 $\mathsf{Red}\,\mathsf{LED}\,(\,\mathsf{R}\,)$ 

|  |  | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 |
|--|--|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
|--|--|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|

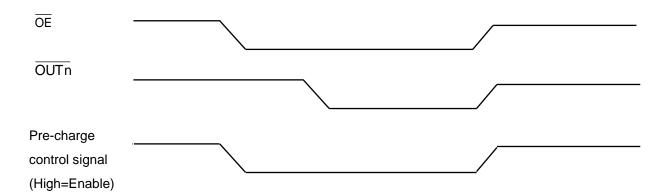
Green LED (G)



Blue LED (B)

| D.40 | ( - ) |   |   |   |   |   |   |   |   |   |   |   |   |   |   |
|------|-------|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| 1    | 1     | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 |

# **Pre-charge waveform**

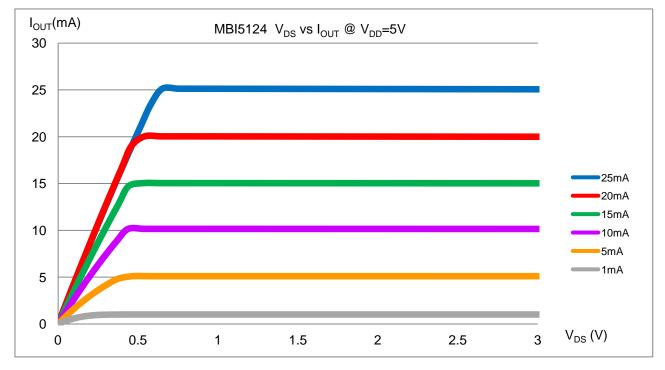


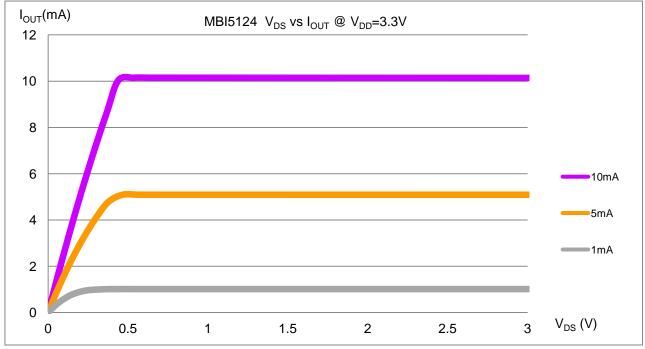
#### **Application Information**

#### **Constant Current**

To design LED displays, MBI5124 provides nearly no variations in current from channel to channel and from IC to IC. This can be achieved by:

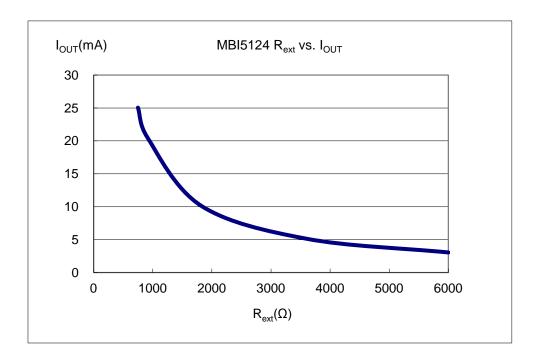
- 1) The maximum current variation between channels is less than ±2.5%, and that between ICs is less than ±3%.
- 2) In addition, the current characteristic of output stage is flat and users can refer to the figure as shown below. The output current can be kept constant regardless of the variations of LED forward voltages (V<sub>F</sub>). This performs as a perfection of load regulation.





#### **Adjusting Output Current**

The output current of each channel ( $I_{OUT}$ ) is set by an external resistor,  $R_{ext}$ . The relationship between  $I_{OUT}$  and  $R_{ext}$  is shown in the following figure.



Also, the output current can be calculated from the equation:

 $V_{R-EXT}$ =1.23V;  $I_{OUT}$ = $V_{R-EXT}$ \*(1/Rext)x15;  $R_{ext}$ =( $V_{R-EXT}$ / $I_{OUT}$ )x15

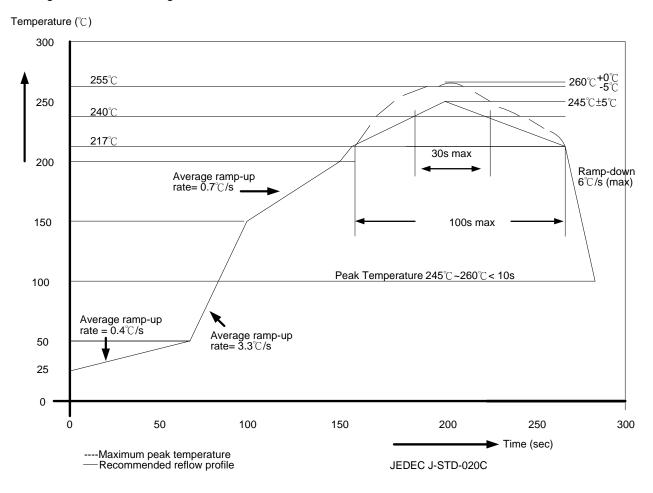
Where  $R_{ext}$  is the resistance of the external resistor connected to R-EXT terminal and  $V_{R-EXT}$  is the voltage of R-EXT terminal. The magnitude of current (as a function of  $R_{ext}$ ) is around 20mA at 930 $\Omega$  and 10mA at 1860 $\Omega$ .

### **Output Staggered Delay**

MBI5124 has a built-in staggered circuit to perform delay mechanism. The 16 output channels are categorized into 2 groups  $\overline{\text{OUT2r}}$  and  $\overline{\text{OUT2n+1}}$ , and each group outputs current by the staggered sequence, 2ns.

#### Soldering Process of "Pb-free & Green" Package Plating\*

Macroblock has defined "Pb-Free & Green" to mean semiconductor products that are compatible with the current RoHS requirements and selected 100% pure tin (Sn) to provide forward and backward compatibility with the higher-temperature Pb-free processes. Pure tin is widely accepted by customers and suppliers of electronic devices in Europe, Asia and the US as the lead-free surface finish of choice to replace tin-lead. Also, it adopts tin/lead (SnPb) solder paste, and please refer to the JEDEC J-STD-020C for the temperature of solder bath. However, in the whole Pb-free soldering processes and materials, 100% pure tin (Sn) will all require from 245 °C to 260°C for proper soldering on boards, referring to JEDEC J-STD-020C as shown below.



| Package Thickness | Volume mm <sup>3</sup><br><350 | Volume mm <sup>3</sup><br>350-2000 | Volume mm³<br>≥2000 |
|-------------------|--------------------------------|------------------------------------|---------------------|
| <1.6mm            | 260 +0 °C                      | 260 +0 °C                          | 260 +0 °C           |
| 1.6mm – 2.5mm     | 260 +0 °C                      | 250 +0 °C                          | 245 +0 °C           |
| ≧2.5mm            | 250 +0 °C                      | 245 +0 °C                          | 245 +0 °C           |

<sup>\*</sup>For details, please refer to Macroblock's "Policy on Pb-free & Green Package".

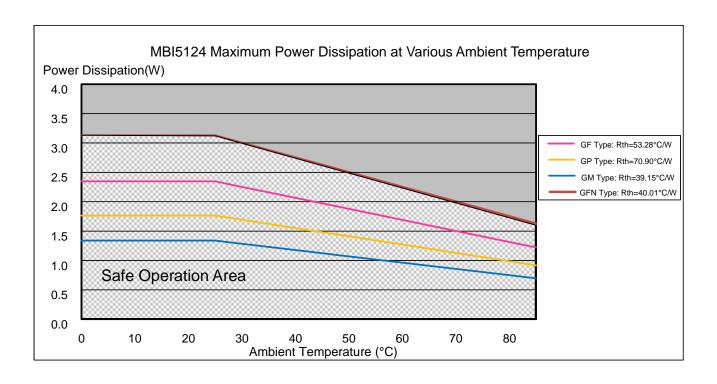
#### Package Power Dissipation (PD)

The maximum allowable package power dissipation is determined as  $P_D(max) = (Tj-Ta)/R_{th(j-a)}$ . When 16 output channels are turned on simultaneously, the actual package power dissipation is

 $P_D(act)=(I_{DD}xV_{DD})+(I_{OUT}xDutyxV_{DS}x16)$ . Therefore, to keep  $P_D(act)\leq P_D(max)$ , the allowable maximum output current as a function of duty cycle is:

 $I_{OUT} = \{ [(Tj-Ta)/R_{th(j-a)}] - (I_{DD}xV_{DD})\}/V_{DS}/Duty/16, \text{ where Tj=150°C}.$ 

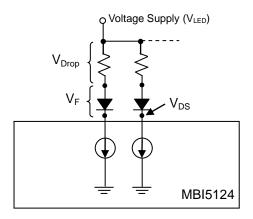
| Package | $R_{th(j-a)}$ (°C/W) | $P_D(W)$ |
|---------|----------------------|----------|
| GF      | 53.28                | 2.34     |
| GP      | 70.90                | 1.76     |
| GM      | 93.50                | 1.33     |

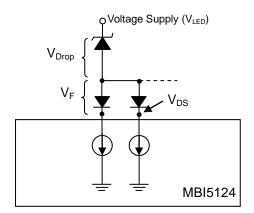


MBI5124 are designed to operate with  $V_{DS}$  ranging from 0.4V to 0.8V (depending on  $I_{OUT}=1\sim25$ mA) considering the package power dissipating limits.  $V_{DS}$  may be higher enough to make  $P_{D(act)}>P_{D(max)}$  when  $V_{LED}=5$ V and  $V_{DS}=V_{LED}-V_F$ , in which  $V_{LED}$  is the load supply voltage. In this case, it is recommended to use the lowest possible supply voltage or to set an external voltage reducer,  $V_{DROP}$ .

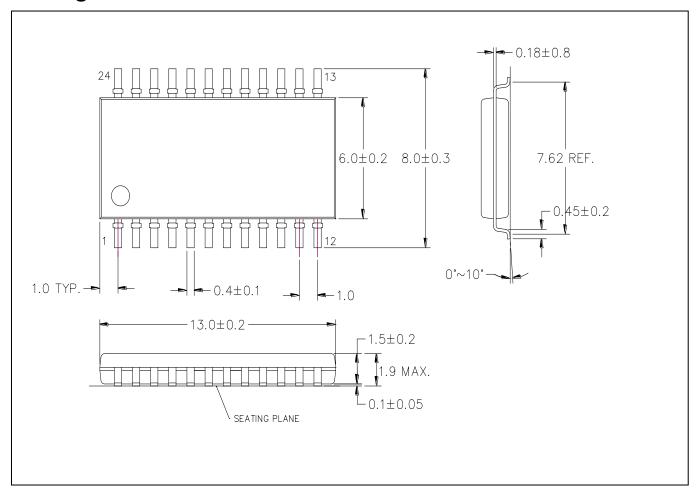
A voltage reducer lets  $V_{DS}=(V_{LED}-V_F)-V_{DROP}$ .

Resistors or Zener diode can be used in the applications as shown in the following figures.



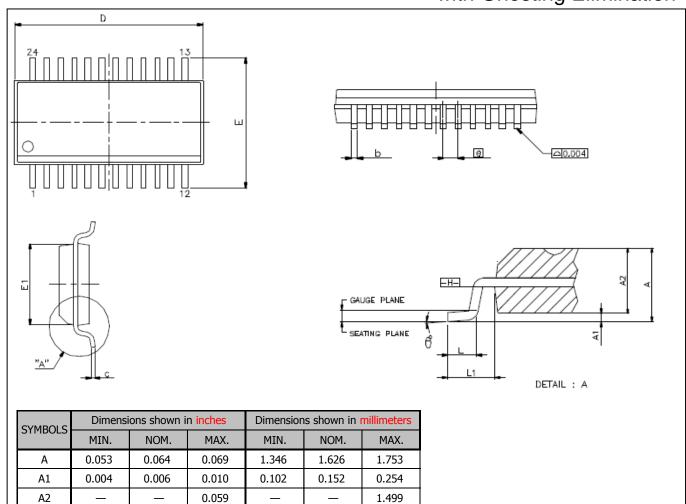


# **Package Outline**



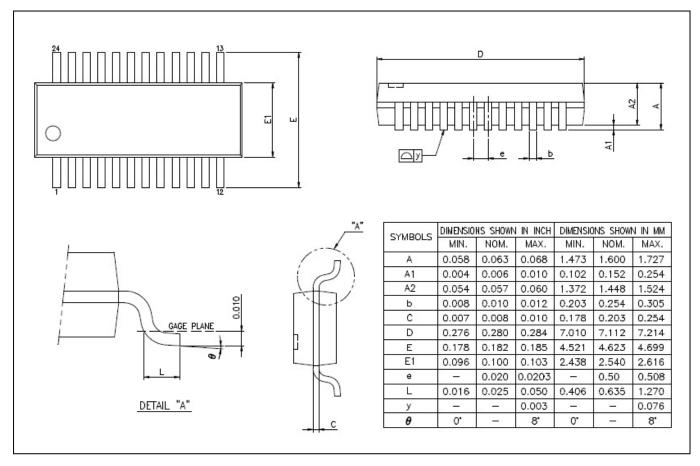
MBI5124GF Outline Drawing

Note: The unit for the outline drawing is mm

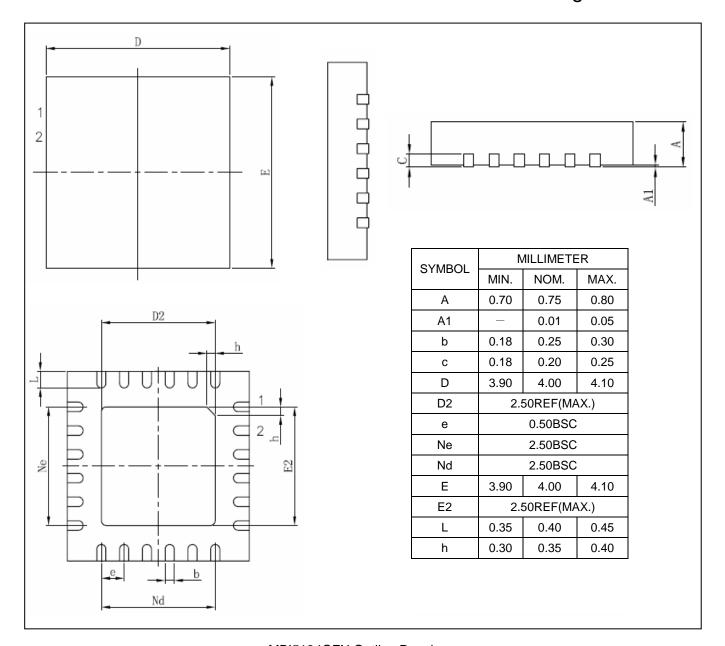


D 0.337 0.341 0.344 8.560 8.661 8.738 Ε 0.228 0.236 0.244 5.791 5.994 6.198 E1 0.150 0.154 0.157 3.810 3.988 3.912 0.008 0.203 b 0.012 0.305 0.007 0.010 0.178 0.254 L 0.016 0.025 0.050 0.406 0.635 1.270 е 0.025 BASIC 0.635 BASIC 0.041 BASIC 1.0414 BASIC L1 0 8 θ 0 8

MBI5124GP Outline Drawing



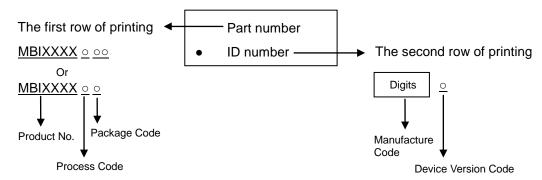
MBI5120GM Outline Drawing



MBI5124GFN Outline Drawing

Note: The thermal pad size may exist a tolerance due to the manufacturing process, please use the maximum dimensions-D2(max. 2.50mm) x E2(max. 2.50mm) for the thermal pad layout. In addition, to avoid the short circuit risk, the vias or circuit traces shall not pass through the maximum area of thermal pad.

#### **Product Top-mark Information**



### **Product Revision History**

| Datasheet Version | Device Version Code |
|-------------------|---------------------|
| V1.00             | A                   |
| V1.01             | A                   |
| V1.02             | A                   |
| V0.01             | В                   |

### **Product Ordering Information**

| Product Ordering Number* | RoHS Compliant Package Type | Weight (g) |
|--------------------------|-----------------------------|------------|
| MBI5124GF-B              | SOP24L-300-1.00             | 0.28       |
| MBI5124GP-B              | SSOP24L-150-0.64            | 0.11       |
| MBI5124GM-B              | mSSOP24L-100-0.5            | 0.079      |
| MBI5124GFN-B             | QFN24L-4*4-0.5              | 0.0379     |

<sup>\*</sup>Please place your order with the "product ordering number" information on your purchase order (PO).

#### **Disclaimer**

Macroblock reserves the right to make changes, corrections, modifications, and improvements to their products and documents or discontinue any product or service. Customers are advised to consult their sales representative for the latest product information before ordering. All products are sold subject to the terms and conditions supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

Macroblock's products are not designed to be used as components in device intended to support or sustain life or in military applications. Use of Macroblock's products in components intended for surgical implant into the body, or other applications in which failure of Macroblock's products could create a situation where personal death or injury may occur, is not authorized without the express written approval of the Managing Director of Macroblock. Macroblock will not be held liable for any damages or claims resulting from the use of its products in medical and military applications.

All text, images, logos and information contained on this document is the intellectual property of Macroblock. Unauthorized reproduction, duplication, extraction, use or disclosure of the above mentioned intellectual property will be deemed as infringement.

### **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for LED Display Drivers category:

Click to view products by MBI manufacturer:

Other Similar products are found below:

STP16CPP05XTTR SCT2027CSSG KP22306WGA KP1199AWPA KP1199BWPA WS9088AS7P GN1628T BCT3236EGH-TR
HT1628BRWZ KP1192SPA KP1182SPA KP1262FSPA KP1072LSPA KP1191SPA KP18001WPA KP1070LSPA KP1221SPA
KP107ALSPA GN1640T MBI5253GP-A MBI5124GM-B WS90561T S7P WS9821B S7P WS9032GS7P LYT3315D M08888G-11
M08890G-13 SCT2001ASIG SCT2024CSOG SCT2024CSSG AL8400QSE-7 PR4401 PR4403 PCA9685PW STP16CPC05XTTR
WS2821B PR4402 M08898G-13 RT8471GJ5 RT9284A-20GJ6E TLC59482DBQR ISL97634IRT14Z-TK AW36413CSR LP5562TMX
WS2818B BCR401R BCR401U BCR402U SCT2004CSOG SCT2026CSOG